

# N- and P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
	V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)			
N-Channel	20	0.0145 at V <sub>GS</sub> = 10 V	9.6			
	20	0.017 at V <sub>GS</sub> = 4.5 V	8.6			
P-Channel	20	0.033 at V <sub>GS</sub> = - 4.5 V	- 6.2			
	- 20	0.050 at V <sub>GS</sub> = - 2.5 V	- 5			

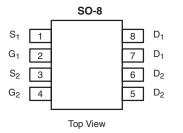
#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- Compliant to RoHS directive 2002/95/EC

#### **APPLICATIONS**

- Level Shift
- · Load Switch

G<sub>1</sub>



Ordering Information: Si4511DY-T1-E3 (Lead (Pb)-free) Si4511DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted							
			N-	Channel	P-Channel		
Parameter		Symbol	10 s	Steady State	10 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	20		- 20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 16		± 12		v
Continuous Drain Current (T <sub>1</sub> = 150 °C) <sup>a, b</sup>	T <sub>A</sub> = 25 °C	I <sub>D</sub>	9.6	7.2	- 6.2	- 4.6	
Continuous Drain Current $(I_J = 150 °C)^{-1}$	T <sub>A</sub> = 70 °C		7.7	5.8	- 4.9	- 3.7	А
Pulsed Drain Current		I <sub>DM</sub>		40		~	
Continuous Source Current (Diode Conduction) <sup>a</sup>		۱ <sub>S</sub>	1.7	0.9	- 1.7	- 0.9	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	- P <sub>D</sub>	2	1.1	2	1.1	w
	T <sub>A</sub> = 70 °C	۰D	1.3	0.7	1.3	0.7	vv
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150				°C

#### THERMAL RESISTANCE RATINGS

			N-Ch	annel	P-Ch	annel	
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit
Mauineune lungtion to Anabianta	t ≤ 10 s	R <sub>thJA</sub>	50	62.5	50	62.5	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State	' 'thJA	85	110	90	110	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	30	40	30	35	

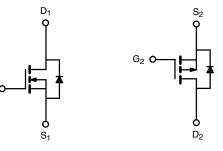
Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. t ≤ 10 s.



Available





Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit	
Static								
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	N-Ch	0.6		1.8	v	
		$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	P-Ch	- 0.6		- 1.4	V	
Gate-Body Leakage		$V_{DS} = 0 V, V_{GS} = \pm 16 V$	N-Ch			± 100	~^	
	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	P-Ch			± 100	nA	
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	N-Ch			1		
		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	P-Ch			- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	N-Ch			5	μΑ	
	-	$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	P-Ch			- 5		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	N-Ch	40				
		$V_{DS} = -5 V, V_{GS} = -4.5 V$	P-Ch	- 40			A	
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9.6 A	N-Ch		0.0115	0.0145	Ω	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 6.2 A	P-Ch		0.022	0.033		
		$V_{GS} = 4.5 \text{ V}, I_D = 8.6 \text{ A}$	N-Ch		0.0135	0.017		
		V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 5 A	P-Ch		0.035	0.050		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 9.6 A	N-Ch		33		_	
		V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 6.2 A	P-Ch		17		S	
h	V <sub>SD</sub>	I <sub>S</sub> = 1.7 A, V <sub>GS</sub> = 0 V	N-Ch		0.8	1.2	.,	
Diode Forward Voltag <sup>b</sup>		I <sub>S</sub> = - 1.7 A, V <sub>GS</sub> = 0 V	P-Ch		- 0.8	- 1.2	V	
Dynamic <sup>a</sup>					•			
Total Gate Charge	Qg	N-Channel $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 9.6 \text{ A}$	N-Ch		11.5	18		
Total Gate Charge			P-Ch		17	20		
Gate-Source Charge	Q <sub>gs</sub> Q <sub>qd</sub>	$v_{\rm DS} = 10$ v, $v_{\rm GS} = 4.5$ v, $t_{\rm D} = 9.6$ A	N-Ch		3.7		nC	
		P-Channel	P-Ch		4.1			
Gate-Drain Charge		$V_{DS}$ = - 10 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 6.2 A	N-Ch		3.3			
	0		P-Ch N-Ch		4.3 12	20		
Turn-On Delay Time Rise Time	t <sub>d(on)</sub> t <sub>r</sub>	N-Channel	P-Ch		25	20 40	_	
		$V_{DD}$ = 10 V, $R_L$ = 10 $\Omega$	N-Ch		12	20		
		$\text{I}_\text{D}\cong$ 1 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 6 $\Omega$	P-Ch		30	45		
Turn-Off Delay Time	t <sub>d(off)</sub>	P-Channel	N-Ch		55	85		
		$V_{DD} = -10 \text{ V}, \text{ R}_{L} = 10 \Omega$	P-Ch		70	105	ns	
Fall Time	t <sub>f</sub>	$I_D \cong$ - 1 Å, $V_{GEN}$ = - 4.5 V, $R_g$ = 6 $\Omega$	N-Ch		15	25		
	т	Ŭ	P-Ch		50	75		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 1.7 A, dl/dt = 100 A/μs	N-Ch		50	100		
Source-Drain neverse necovery Time	۰rr	I <sub>F</sub> = - 1.7 A, dl/dt = 100 A/μs	P-Ch		40	80		

Notes:

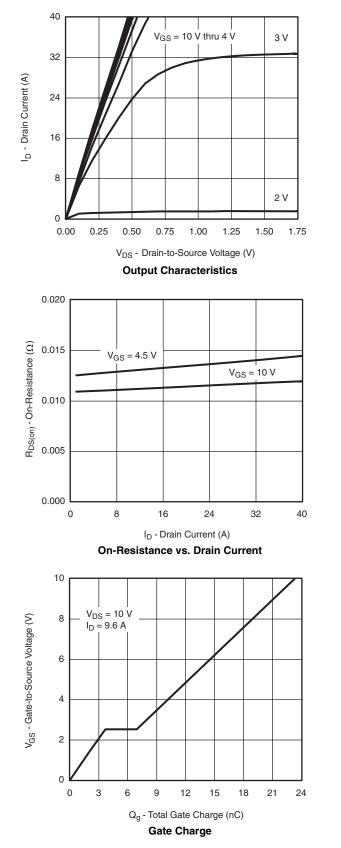
a. Guaranteed by design, not subject to production testing.

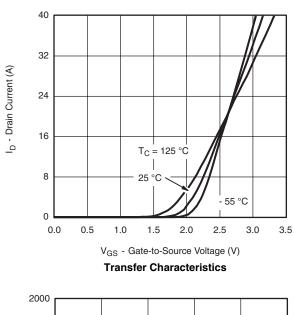
b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

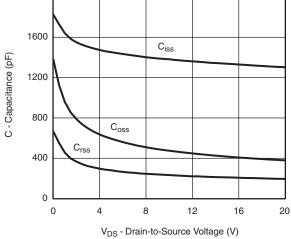
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



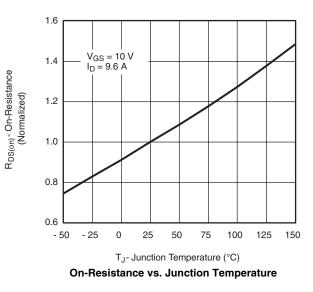
### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





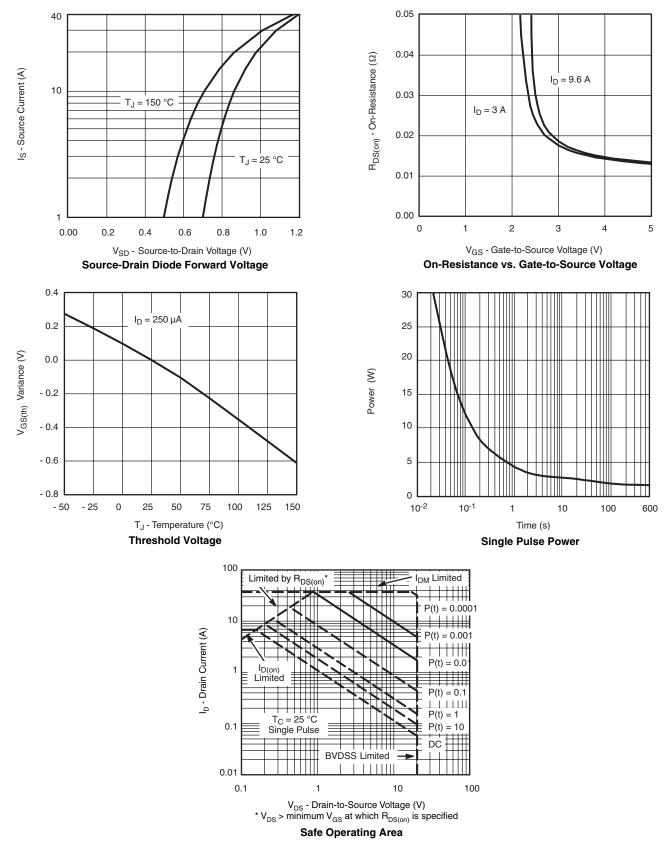




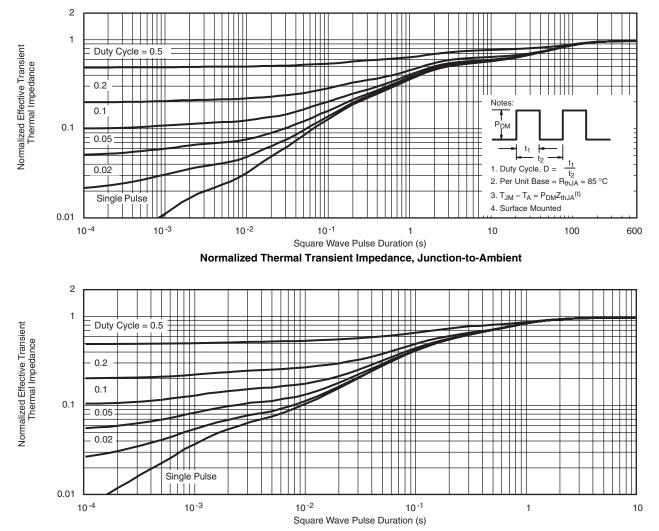


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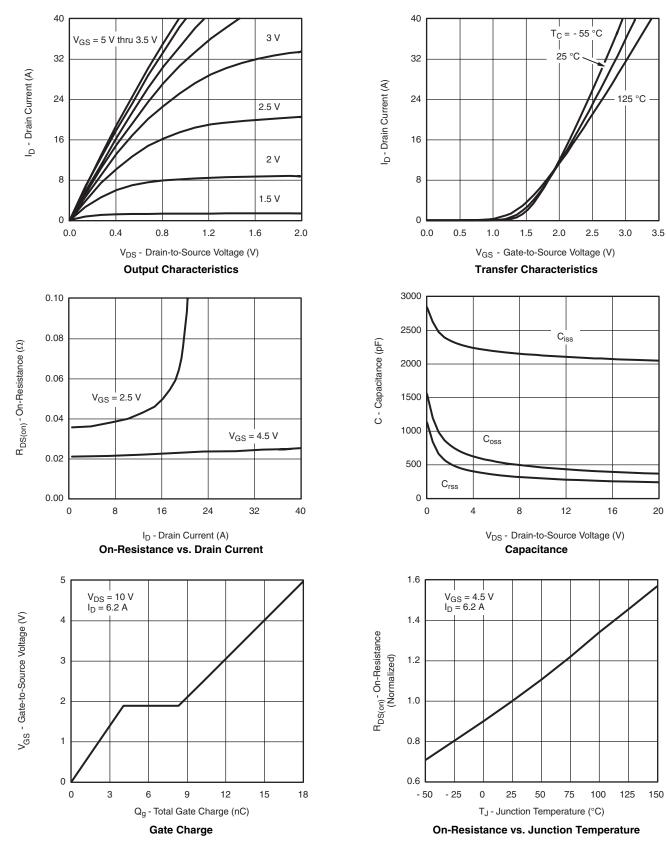
Normalized Thermal Transient Impedance, Junction-to-Foot

# Si4511DY



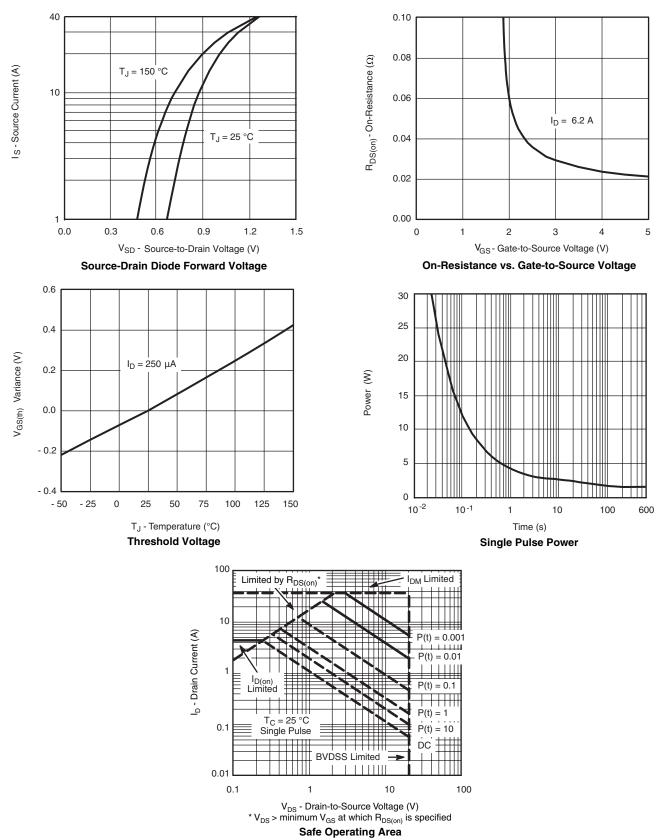
## Vishay Siliconix

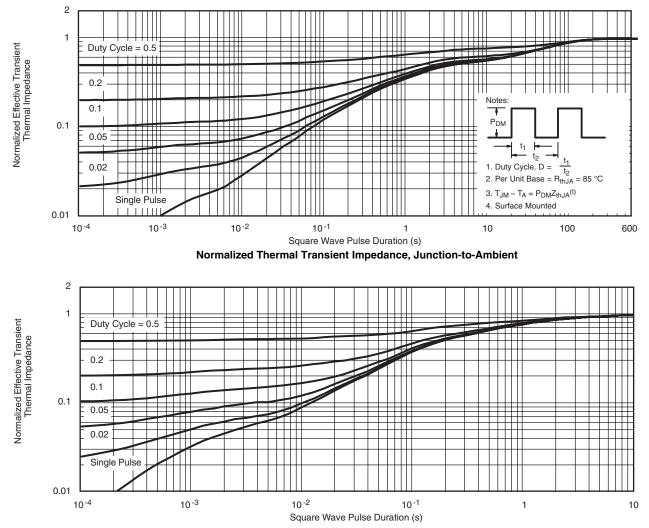
### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot

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